



#### DMN62D0LFB

#### N-CHANNEL ENHANCEMENT MODE MOSFET

#### **Product Summary**

| V <sub>(BR)DSS</sub> | Rds(on)                       | Ι <sub>D</sub><br>T <sub>A</sub> = +25°C |  |
|----------------------|-------------------------------|--|--|
| 60V                  | 2Ω @ V <sub>GS</sub> = 4V     | 100mA                                    |  |
|                      | 2.5Ω @ V <sub>GS</sub> = 2.5V | 50mA                                     |  |

#### **Description and Applications**

This new generation MOSFET is designed to minimize the on-state resistance ( $R_{DS(ON)}$ ) and yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

- DC-DC Converters
- Power Management Functions
- Battery Operated Systems and Solid-State Relays
- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories, Transistors, etc.

### **Features and Benefits**

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- ESD Protected
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

#### Mechanical Data

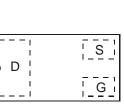
- Case: X1-DFN1006-3
- Case Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @
- Weight: 0.001 grams (Approximate)





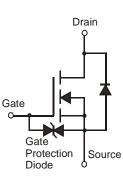
X1-DFN1006-3

Bottom View



Top View

Pin-Out



Equivalent Circuit

#### Ordering Information (Note 4)

Notes:

| Product       | Marking | Reel size (inches) | Tape width (mm) | Quantity per reel |
|---------------|---------|--------------------|-----------------|-------------------|
| DMN62D0LFB-7  | NK      | 7                  | 8               | 3,000             |
| DMN62D0LFB-7B | NK      | 7                  | 8               | 10,000            |

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.



#### Marking Information

| DMN62D0LFB-7  | From date code 1527 (YYWW),<br>this changes to:<br>Top View<br>Dot Denotes Drain Side<br>Top View<br>Bar Denotes Gate and Source Side<br>Top View<br>Bar Denotes Gate and Source Side<br>Top View<br>Bar Denotes Gate and Source Side   |
|---------------|---|
| DMN62D0LFB-7B | Top View<br>Bar Denotes Gate and Source Side<br>Top View NK = Part Marking Code   Image: Constraint of the second seco |

#### Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.) Characteristic Symbol Value Unit Drain-Source Voltage 60 VDSS V ٧ Gate-Source Voltage ±20 V<sub>GSS</sub> $T_A = +25^{\circ}C$ 100 Steady mΑ Continuous Drain Current (Note 5) VGS = 4.0V $I_{\mathsf{D}}$ State 75 $T_{A} = +70^{\circ}C$ 200 Pulsed Drain Current (Note 6) $I_{DM}$ mΑ

### **Thermal Characteristics**

| Characteristic   | Symbol           | Max         | Unit |
|--|------------------|-------------|------|
| Power Dissipation (Note 5)   | PD               | 0.47        | W    |
| Thermal Resistance, Junction to Ambient $@T_A = +25^{\circ}C$ (Note 5) | R <sub>0JA</sub> | 258         | °C/W |
| Operating and Storage Temperature Range                                | TJ, TSTG         | -55 to +150 | °C   |

Notes: 5. Device mounted on FR-4 PCB with minimum recommended pad layout, single sided.

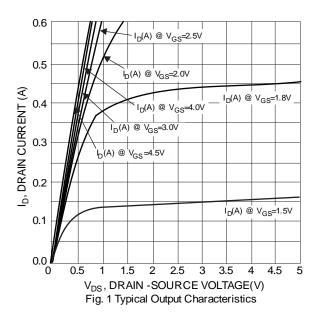
6. Repetitive rating, pulse width limited by junction temperature.

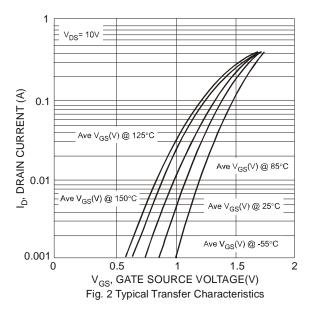


### Electrical Characteristics (@ T<sub>A</sub> = +25°C, unless otherwise stated.)

|  |                      |     | _    |      |      |   |  |
|--|----------------------|-----|------|------|------|---|--|
| Characteristic   | Symbol               | Min | Тур  | Max  | Unit | Test Condition                                  |  |
| OFF CHARACTERISTICS (Note 7)                           |                      |     | r    | 1    |      |   |  |
| Drain-Source Breakdown Voltage                         | BV <sub>DSS</sub>    | 60  | -    | -    | V    | $V_{GS} = 0V, I_D = 250\mu A$                   |  |
| Zero Gate Voltage Drain Current T <sub>J</sub> = +25°C | I <sub>DSS</sub>     | -   | -    | 1.0  | μA   | $V_{DS} = 60V, V_{GS} = 0V$                     |  |
|  |                      | -   | -    | ±100 | nA   | $V_{GS} = \pm 5V, V_{DS} = 0V$                  |  |
| Gate-Source Leakage                                    | I <sub>GSS</sub>     | -   | -    | ±500 | nA   | $V_{GS} = \pm 10V, V_{DS} = 0V$                 |  |
|  |                      | -   | -    | ±2.0 | μA   | $V_{GS} = \pm 15V$ , $V_{DS} = 0V$              |  |
| ON CHARACTERISTICS (Note 7)                            |                      |     |      |      |      |   |  |
| Gate Threshold Voltage                                 | V <sub>GS(TH)</sub>  | 0.6 | -    | 1.0  | V    | $V_{DS} = V_{GS}$ , $I_D = 250 \mu A$           |  |
|  |                      | -   | 1.3  | 2    |      | $V_{GS} = 4V, I_D = 100mA$                      |  |
| Static Drain-Source On-Resistance                      | Р                    | -   | 1.5  | 2.5  | Ω    | $V_{GS} = 2.5V, I_D = 50mA$                     |  |
| Static Drain-Source On-Resistance                      | R <sub>DS (ON)</sub> | -   | 1.9  | 3    | Ω    | $V_{GS} = 1.8V, I_D = 50mA$                     |  |
|  |                      | -   | 2.6  | -    |      | $V_{GS} = 1.5V, I_D = 10mA$                     |  |
| Forward Transfer Admittance                            | Y <sub>fs</sub>      | -   | 0.8  | -    | S    | $V_{DS} = 10V, I_D = 200mA$                     |  |
| Diode Forward Voltage                                  | V <sub>SD</sub>      | -   | 0.9  | 1.3  | V    | $V_{GS} = 0V, I_{S} = 115mA$                    |  |
| DYNAMIC CHARACTERISTICS (Note 8)                       |                      |     |      |      |      |   |  |
| Input Capacitance                                      | Ciss                 | -   | 32   | 64   |      | $V_{DS} = 25V, V_{GS} = 0V,$<br>f = 1.0MHz      |  |
| Output Capacitance                                     | C <sub>oss</sub>     | -   | 4.4  | 9    | pF   |   |  |
| Reverse Transfer Capacitance                           | C <sub>rss</sub>     | -   | 2.9  | 6    |      |   |  |
| Gate Resistance  | Rg                   | -   | 126  | 250  | Ω    | $V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$      |  |
| Total Gate Charge                                      | Qg                   | -   | 0.45 | 0.9  |      |   |  |
| Gate-Source Charge                                     | Q <sub>gs</sub>      | -   | 0.08 | 0.2  | nC   | $V_{GS} = 4.5V, V_{DS} = 10V,$<br>$I_D = 250mA$ |  |
| Gate-Drain Charge                                      | Q <sub>gd</sub>      | -   | 0.08 | 0.2  |      |   |  |
| Turn-On Delay Time                                     | t <sub>D(ON)</sub>   | -   | 3.4  | 10   | ns   |   |  |
| Turn-On Rise Time                                      | t <sub>R</sub>       | -   | 3.4  | 10   | ns   | $V_{GS} = 10V, V_{DS} = 30V,$                   |  |
| Turn-Off Delay Time                                    | t <sub>D(OFF)</sub>  | -   | 26.4 | 45   | ns   | $R_{L} = 150\Omega, R_{G} = 25\Omega,$          |  |
| Turn-Off Fall Time                                     | tF                   | -   | 16.3 | 30   | ns   | $-I_D = 200 \text{mA}$                          |  |

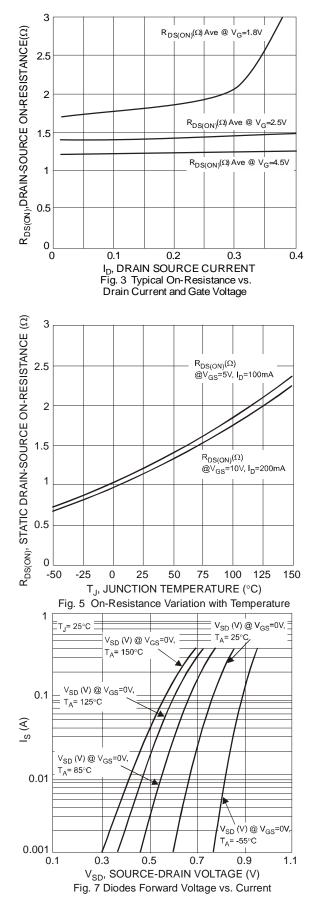
Notes: 7. Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to production testing.

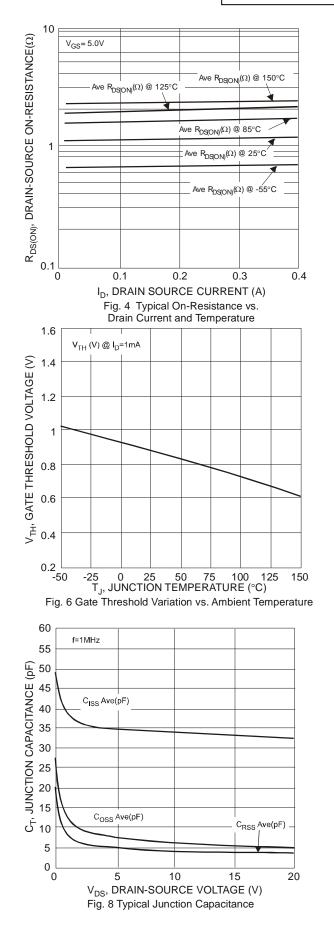




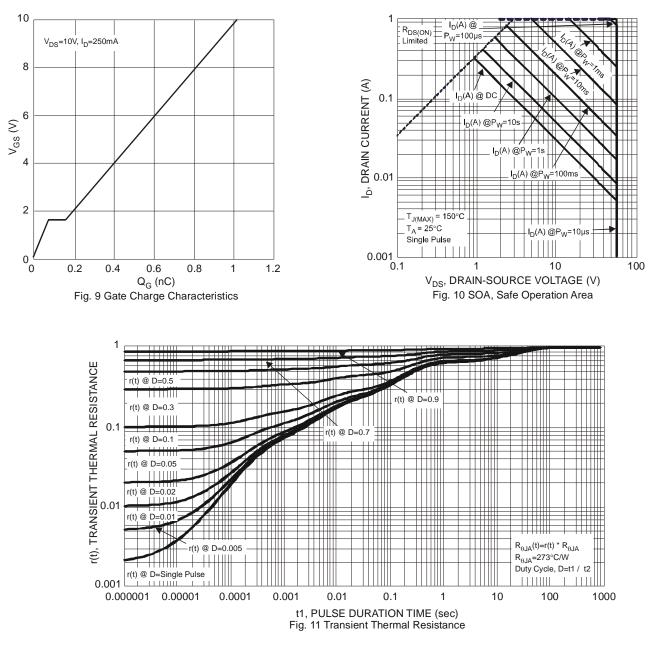


#### DMN62D0LFB





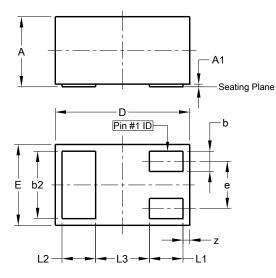






## **Package Outline Dimensions**

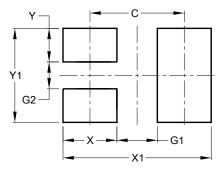
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



| Х     | X1-DFN1006-3         |       |      |  |  |
|-------|----------------------|-------|------|--|--|
| Dim   | Min                  | Max   | Тур  |  |  |
| Α     | 0.47                 | 0.53  | 0.50 |  |  |
| A1    | 0.00                 | 0.05  | 0.03 |  |  |
| b     | 0.10                 | 0.20  | 0.15 |  |  |
| b2    | 0.45                 | 0.55  | 0.50 |  |  |
| D     | 0.95                 | 1.075 | 1.00 |  |  |
| Е     | 0.55                 | 0.675 | 0.60 |  |  |
| е     | -                    | -     | 0.35 |  |  |
| L1    | 0.20                 | 0.30  | 0.25 |  |  |
| L2    | 0.20                 | 0.30  | 0.25 |  |  |
| L3    | -                    | -     | 0.40 |  |  |
| z     | 0.02                 | 0.08  | 0.05 |  |  |
| All D | All Dimensions in mm |       |      |  |  |

### Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| С          | 0.70          |
| G1         | 0.30          |
| G2         | 0.20          |
| Х          | 0.40          |
| X1         | 1.10          |
| Ŷ          | 0.25          |
| Y1         | 0.70          |



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